

PATENT ASSIGNMENT

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NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hiromi NOTANI	06/13/2011
Issei KASHIMA	06/13/2011
RECEIVING PARTY DATA	
Name:	RENESAS ELECTRONICS CORPORATION
Street Address:	1753, Shimonumabe, Nakahara-ku, Kawasaki-shi
City:	Kanagawa
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13184030
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ATTORNEY DOCKET NUMBER:	067237-0685
NAME OF SUBMITTER:	Stephen A. Becker
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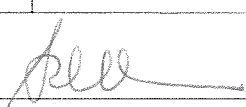
PATENT
REEL: 026600 FRAME: 0755

RECORDATION FORM COVER SHEET

Docket No.: 067237-0685

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies) Hiromi NOTANI, Issei KASHIMA Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input type="checkbox"/> No	2. Name and address of receiving party(ies) Name: RENESAS ELECTRONICS CORPORATION Internal Address: Address: 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa JAPAN Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input type="checkbox"/> No
3. Nature of Conveyance/Execution Date(s) Execution Date(s): June 13, 2011 <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Joint Research Agreement <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License <input type="checkbox"/> Other	4. Application or patent number(s): A. Patent Application No(s). B. Patent No(s). Additional numbers attached? <input type="checkbox"/> Yes <input type="checkbox"/> No
5. Name and address to whom correspondence concerning document should be mailed: Name: MCDERMOTT WILL & EMERY LLP Internal Address: Street Address: 600 13th Street, N.W. City: Washington, State: DC Zip: 20005-3096 D.C. Phone Number: 202.756.8000 Fax Number: 202.756.8087 Email Address:	6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00 <input type="checkbox"/> Authorized to be charged by credit card <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title)
9. Signature. Stephen A. Becker 26,527	8. Payment Information: a. Credit Card Last 4 Numbers _____ Expiration Date _____ b. Deposit Account Number 500417 Authorized User Name _____
Name and Registration No. of Person Signing Signature Date <div style="text-align: center; margin-top: 10px;">  </div>	
Total number of pages including cover sheet, attachments and documents: 2	

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan, located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Electronics Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Hiromi Notani</u>	Hiromi NOTANI	<u>June 13, 2011</u>
2) <u>Issei Kashima</u>	Issei KASHIMA	<u>June 13, 2011</u>
3) _____		_____
4) _____		_____
5) _____		_____
6) _____		_____
7) _____		_____
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9) _____		_____
10) _____		_____